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# Infrared thermotransmittance-based temperature field measurements in semitransparent media

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## AFFILIATIONS

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## ABSTRACT

Contactless temperature field measurements in or at the surfaces of semitransparent media are a scientific challenge as classical thermography techniques based on proper material emission cannot be used. In this work, an alternative method using infrared thermotransmittance for contactless temperature imaging is proposed. To overcome the weakness of the measured signal, a lock-in acquisition chain is developed and an imaging demodulation technique is used to retrieve the phase and amplitude of the thermotransmitted signal. These measurements, combined with an analytical model, enable the estimation of the thermal diffusivity and conductivity of an infrared semitransparent insulator (wafer of Borofloat 33 glass) and the monochromatic thermotransmittance coefficient at 3.3  $\mu\text{m}$ . The obtained temperature fields are in good agreement with the model, and a detection limit of  $\pm 2^\circ\text{C}$  is estimated with this method. The results of this work open new opportunities in the development of advanced thermal metrology for semitransparent media.

## NOMENCLATURE

$a$	thermal diffusivity ( $\text{m}^2/\text{s}$ )
$A$	transmitted infrared signal
$A_0$	average of the transmitted infrared signal
$c_p$	specific heat capacity ( $\text{J}/\text{kg}/\text{K}$ )
$E$	proper emission signal
$e$	thickness (m)
$f_c$	chopper frequency (Hz)
$f_T$	frequency of the thermal modulation (Hz)
$h$	convection coefficient ( $\text{W}/\text{m}^2/\text{K}$ )
$H$	loss factor ( $\text{m}^{-2}$ )
$I_0$	Bessel function
$k$	thermal conductivity ( $\text{W}/\text{m}/\text{K}$ )
$r$	position (m)
$R$	radius (m)
$S$	signal measured by using the camera
$S_\theta$	sensitivity of the modulus of the temperature (K)
$S_\varphi$	sensitivity of the phase of the temperature (rad)
$T$	temperature (K)
$t$	time (s)

$T_0$	ambient temperature (K)
$T_c$	modulated temperature (K)
$\theta$	amplitude of the modulated temperature (K)
$\kappa$	thermotransmittance coefficient ( $\text{K}^{-1}$ )
$\lambda$	wavelength (m)
$\rho$	mass density ( $\text{kg}/\text{m}^3$ )
$\varphi$	phase (rad)
$\omega_T$	pulsation of the thermal modulation (rad/s)

## I. INTRODUCTION

Infrared (IR) semitransparent materials have been extensively studied in recent years because of their presence in many devices. For example, semiconductors, such as silicon or germanium, are used in batteries<sup>1</sup> and solar panels.<sup>2,3</sup> Some polymers<sup>4</sup> and glasses are also semitransparent and are mainly used in industry. To optimize the thermal performance of devices or monitor industrial processes,<sup>5</sup> contactless measurement of temperature in materials is a major challenge. For thermal imaging measurements, the most widely used method is infrared thermography.<sup>6-9</sup> Although the method is perfectly adapted for opaque materials,<sup>10</sup> it is not

well-suited for semitransparent media. The latter absorb and transmit radiation from their surrounding environment, so discriminating the thermal signal of interest from parasitic radiation remains an obstacle.

Another approach relies on Raman spectroscopy,<sup>11,12</sup> in which the peak position and width are temperature dependent. Raman thermometry is, however, limited to Raman active materials, which excludes many amorphous materials and metals. Furthermore, to avoid excessively long acquisition times, Raman thermometry is often performed with large temperature gradients. Finally, it is intrinsically a point by point technique. Other approaches are based on the thermal dependency of the fluorescence of specific particles. The medium must be inseminated with fluorescent nanoparticles or organic dyes.<sup>13</sup> However, the interactions between the particles and the material are not well known and possibly affect thermal properties of the sample.<sup>14</sup> Thus, the development of a new contactless temperature measurement technique is of prime importance for resolving these issues.

An alternative method relies on the temperature dependency of the optical refractive index of materials.<sup>15–17</sup> Thermorefectance<sup>18–22</sup> uses this characteristic to measure thermal properties and surface temperatures of opaque and reflective materials. Analogous with thermorefectance, thermotransmittance is the study of the thermally induced variation of transmitted light through a semitransparent medium. The variation in the transmitted light is related to the variation in temperature through the thermotransmittance coefficient  $\kappa$ . This parameter depends on the material, the thickness of the sample, and the wavelength of the incident light, but only a few papers have reported thermotransmittance coefficient values of some materials.<sup>23</sup>

This coefficient can be determined either through optical property modeling or by experimental calibration. In the literature, no adequate theoretical model has been reported for estimating the thermotransmittance coefficient, and the infrared range has not been studied. The only other option is to measure the thermotransmittance coefficient of the sample under study. Works reporting such measurements are particularly scarce in the infrared domain and for semitransparent media. To address this challenge, a novel calibration method for the thermotransmittance coefficient is reported in this work.

Although thermotransmittance has been demonstrated to be well suited for temperature measurements in semitransparent materials, its sensitivity is low in the infrared band,<sup>23</sup> i.e.,  $\approx 10^{-4} \text{ K}^{-1}$ . Therefore, careful attention should be given to electronic noise, thermal drift of devices, and parasitic environmental radiation in the signal acquisition chain. To resolve this major issue and improve the signal-to-noise ratio (SNR), modulating the thermal excitation of the sample appears to be a promising approach. Appropriate demodulation enables the signal to be discarded at unwanted frequencies as a lock-in amplifier adapted for imaging systems.<sup>24,25</sup> To demonstrate the performance of the developed method for thermal properties and temperature measurements, an IR semitransparent wafer of Borofloat 33 glass is used to create a temperature gradient within the material. Its thermal properties, namely, its thermal diffusivity and conductivity, are measured based on thermotransmittance and compared to values reported in the literature. Then, the thermotransmittance coefficient of the Borofloat 33 wafer is calibrated to enable temperature measurement in this material.

## II. EXPERIMENTAL SETUP FOR THERMOTRANSMITTANCE MEASUREMENT

This section presents the experimental setup for measuring the thermotransmittance signal of a wafer of Borofloat 33 glass. One of the great advantages of thermotransmittance is its proportionality to temperature variation. All the presented study is based on this property.

### A. Experimental setup

The measurement process consists in detecting the transmitted intensity of an IR beam through the sample of interest with a camera. As the temperature of the sample varies, the transmitted intensity also varies as follows:

$$\frac{\Delta A(t)}{A_0} = \kappa \Delta T(t). \quad (1)$$

Equation (1) expresses the relationship among the averaged signal of the transmitted infrared beam  $A_0$ , the variation of the transmitted signal as a function of temperature  $\Delta A(t)$ , the temperature variation  $\Delta T(t)$ , and the time  $t$ .

The experimental setup for thermotransmittance measurement is represented in Fig. 1. The sample is heated by using an annular Peltier module, with the temperature modulated around  $T_0$  at the frequency  $f_T$ . A thermocouple combined with homemade LabView software enables temperature monitoring.

Upstream, the illumination wavelength is selected with a diffraction grating monochromator (Bentham Instruments, TMc300) from a stabilized infrared lamp (IR-Si217). After the monochromator, a beam expander adjusts the size of the infrared beam to sample dimensions.

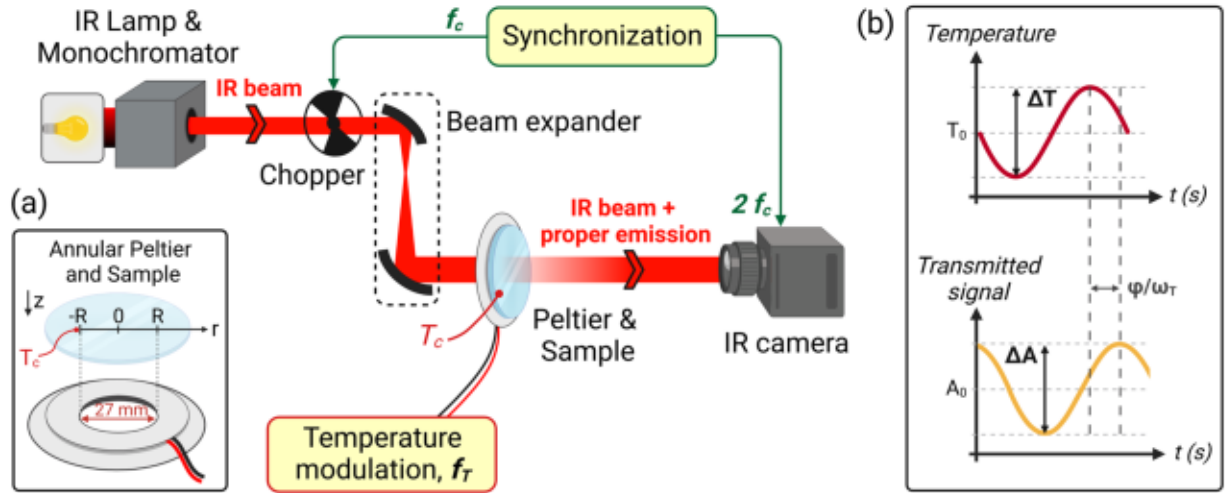
The infrared beam transmitted through the sample is measured by using an infrared camera (FLIR SC7000). The camera is composed of an indium-antimonide detector of  $512 \times 640$  pixels with a pitch of  $15 \mu\text{m}$  and a 50 mm focal length lens. The spectral wavelength range is  $\lambda \in [2.5 - 5.5] \mu\text{m}$ , and the optical resolution in the experimental configuration is  $107 \mu\text{m}/\text{pixel}$ .

The signal  $S$  measured by using the camera is a superposition<sup>26</sup> of the proper emission of scene  $E$  and the infrared beam transmitted by sample  $A$ , i.e.,  $S = E + A$ . The source chopping enables us to separate these contributions: the opening of the chopper provides  $S$  and its closing provides  $E$ . The camera acquisition frame rate is synchronized at twice the chopper frequency  $2f_c$ . Finally,  $A$  is retrieved by subtracting two successive frames [see Fig. 2(b)]. To prevent a change in the proper emission between the subtracted images, the chopper frequency,  $f_c = 25 \text{ Hz}$ , is set much larger than the thermal frequency,  $f_T = 5 \text{ mHz}$ .

To demonstrate this method, we use a semitransparent insulator in the spectral range of the camera. The medium selected for study is a wafer of Borofloat 33 glass.<sup>27</sup> The thickness of the sample is measured with a micrometric caliper,  $e = 515 \pm 10 \mu\text{m}$ , and its diameter is  $d = 50.8 \text{ mm}$ .

### B. Signal processing

To retrieve the amplitude  $\Delta A$  and phase  $\varphi$  of the modulated thermotransmitted signal  $A(t)$ , the four-image method is implemented,<sup>28</sup> as described in Eqs. (2) and (3).

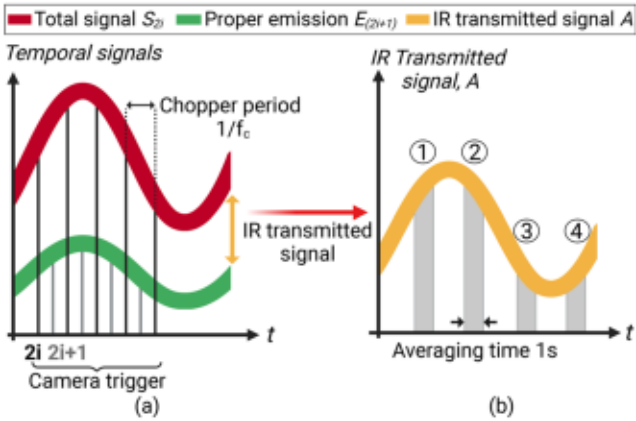


**FIG. 1.** (a) Illustration of the experimental setup:  $f_T$  is the temperature modulation frequency, and  $f_c$  is the chopper frequency. The inset in (a) presents a magnified view of the Peltier module and the sample (wafer of Borofloat 33 glass). (b) Thermotransmittance principle: the temperature variation (red curve) induces a variation in the transmitted signal measured by using the camera at the same frequency (yellow curve).

The signal-to-noise ratio is improved by removing the signal at unwanted frequencies  $f \neq f_T$ . To further reduce the noise, two strategies are implemented. First, measurements are repeated on several periods and averaged. Second, the camera is triggered to record four sets of frames per period [Fig. 2(b)].

Each image  $I_{mi}$  used in the following equations is an average of the corresponding set of frames after proper emission subtraction:

$$\Delta A = \sqrt{(I_{m1} - I_{m3})^2 + (I_{m2} - I_{m4})^2}, \quad (2)$$

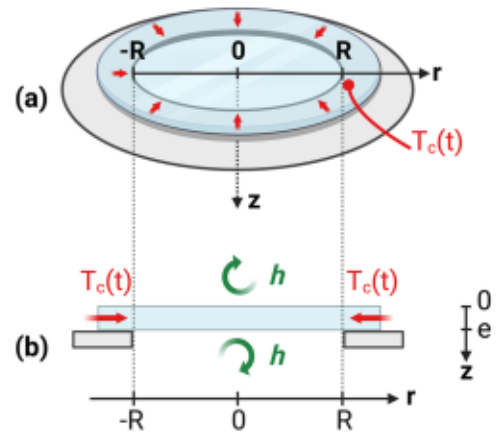


**FIG. 2.** (a) Temporal signals of one pixel, measured by using the camera at a frequency of  $2f_c$ . The proper emission  $E$  is captured at odd frames  $2i + 1$ , and the total signal  $S = E + A$  is captured at even frames  $2i$ . Subtracting the proper emission from the total signal yields the transmitted IR signal  $A$ . (b) Illustration of the four sets of frames used for amplitude and phase measurements of a sine wave temperature modulation.

$$\varphi = \tan^{-1} \left( \frac{I_{m4} - I_{m2}}{I_{m1} - I_{m3}} \right) + \varphi_0. \quad (3)$$

### C. Heat transport modeling

The heat transfer across the system is modeled to validate experimental thermotransmittance measurements and to estimate its thermal properties. We consider a sample of radius  $R$  and thickness  $e$ , with a thermal diffusivity  $a$  ( $\text{m}^2/\text{s}$ ) and a thermal conductivity  $k$  ( $\text{W}/\text{m}/\text{K}$ ). At the edges (Fig. 3), namely, where  $r = R$  and  $r = -R$ , the temperature is set to the modulated temperature  $T_c(t)$ . For symmetry reasons, at the position  $r = 0$ , the flux is assumed to be equal to zero, and convection losses are imposed at  $z = 0$  and  $z = e$ , with



**FIG. 3.** (a) Three-dimensional view of the Peltier module and the sample heated to a modulated temperature  $T_c(t)$ . (b) Cross-sectional view of the Borofloat 33 glass wafer, with the associated boundary conditions.



$h$  being the convection coefficient. The heat equation in cylindrical coordinates and the associated boundary conditions are expressed in the following equations:

$$\left\{ \begin{aligned} \frac{\partial^2 T(r, z, t)}{\partial r^2} + \frac{1}{r} \frac{\partial T(r, z, t)}{\partial r} + \frac{\partial^2 T(r, z, t)}{\partial z^2} &= \frac{1}{a} \frac{\partial T(r, z, t)}{\partial t}, \end{aligned} \right. \quad (4)$$

$$\left. \begin{aligned} -k \frac{\partial T(r, z, t)}{\partial z} \Big|_{z=0} &= -h(T(r, z=0, t) - T_0), \end{aligned} \right. \quad (5)$$

$$\left. \begin{aligned} -k \frac{\partial T(r, z, t)}{\partial z} \Big|_{z=e} &= h(T(r, z=e, t) - T_0). \end{aligned} \right. \quad (6)$$

$$\left. \begin{aligned} -k \frac{\partial T(r, z, t)}{\partial r} \Big|_{r=0} &= 0, \end{aligned} \right. \quad (7)$$

$$\left\{ \begin{aligned} T(r = R, z, t) = T(r = -R, z, t) &= T_c(t) \\ &= T_0 + \frac{\Delta T}{2} \sin(\omega_T t), \end{aligned} \right. \quad (8)$$

$$\left\{ \begin{aligned} T(r, z, t = 0) &= T_0. \end{aligned} \right. \quad (9)$$

The Biot number of the wafer of Borofloat 33 is  $B_i = he/k \approx 5 \times 10^{-3} \ll 1$ , with  $k \approx 1$  W/m/K and  $h \approx 10$  W/m<sup>2</sup>/K for the vertical configuration<sup>29</sup> used in our setup. Therefore, the temperature along the  $z$ -dimension should be uniform, and the partial derivative with respect to  $z$  can be linearized,

$$\begin{aligned} \frac{\partial^2 T(r, z, t)}{\partial z^2} &\approx \frac{\frac{\partial T(r, z, t)}{\partial z} \Big|_{z=e} - \frac{\partial T(r, z, t)}{\partial z} \Big|_{z=0}}{e} \\ &\approx -\frac{2h}{ke} (T(r, z=e, t) - T_0). \end{aligned} \quad (10)$$

To solve the system, the temperature is decomposed into a constant and a term depending on the pulsation  $\omega_T = 2\pi f_T$ ,

$$T(r, t) = T_0 + \theta(r, \omega_T) e^{i\omega_T t}. \quad (11)$$

The previous system of equations [from Eqs. (4)–(9)] becomes

$$\left\{ \begin{aligned} \frac{d^2 \theta(r, \omega_T)}{dr^2} + \frac{1}{r} \frac{d\theta(r, \omega_T)}{dr} &= \left( \frac{i\omega_T}{a} + \frac{2h}{ke} \right) \theta(r, \omega_T), \end{aligned} \right. \quad (12)$$

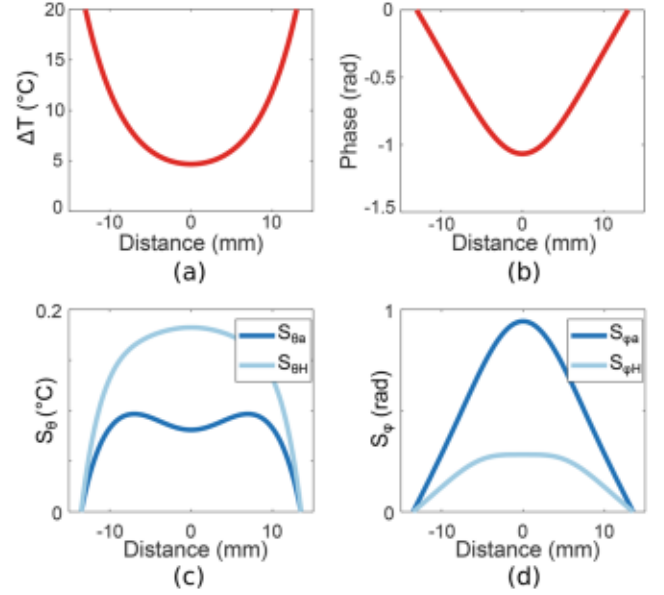
$$\left. \begin{aligned} -k \frac{d\theta(r, \omega_T)}{dr} \Big|_{r=0} &= 0, \end{aligned} \right. \quad (13)$$

$$\left\{ \begin{aligned} \theta(r = R, \omega_T) &= \theta_c(\omega_T). \end{aligned} \right. \quad (14)$$

The solution of the system is a modified Bessel function of the first kind  $I_0$ .<sup>30</sup> Finally, the complex temperature field in the sample as a function of the position  $r$  and the frequency  $f_T = 2\pi/\omega_T$  is expressed as follows:

$$\theta(r, \omega_T) = \theta_c(\omega_T) \frac{I_0\left(r\sqrt{H + i\frac{\omega_T}{a}}\right)}{I_0\left(R\sqrt{H + i\frac{\omega_T}{a}}\right)}, \quad (15)$$

where  $H = 2h/ke$  is the loss factor. The amplitude and phase of the complex temperature  $\theta(r, \omega_T)$  are shown in Figs. 4(a) and 4(b).



**FIG. 4.** Amplitude (a) and phase (b) of the expected temperature variation as functions of the distance  $r$ . Amplitude (c) and phase (d) sensitivities as functions of  $a$  and  $H$ .

#### D. Sensitivity analysis

A sensitivity study [Figs. 4(c) and 4(d)] is performed to determine the influence of thermal properties on the measured amplitude and phase and to adapt the minimization algorithm [see Eq. (19)]. A variation of 10% is applied to the thermal diffusivity  $a$  and the term  $H$ . The sensitivities of the amplitude  $S_\theta$  and phase  $S_\phi$  to  $a$  and  $H$  are expressed in detail in the following equations:

$$S_{\theta a} = a \frac{\partial |\theta(a, H)|}{\partial a}, \quad S_{\theta H} = H \frac{\partial |\theta(a, H)|}{\partial H}, \quad (16)$$

$$S_{\phi a} = a \frac{\partial \phi(a, H)}{\partial a}, \quad S_{\phi H} = H \frac{\partial \phi(a, H)}{\partial H}. \quad (17)$$

According to the characteristics of the material and the geometry of the setup, the values used in the model are  $a = 7 \times 10^{-7}$  m<sup>2</sup>/s,  $H = 3.45 \times 10^4$  m<sup>-2</sup>,  $k = 1$  W/m/K,  $R = 13.5$  mm,  $e = 0.5$  mm,  $\theta_c = 20^\circ$  C, and  $f_T = 5$  mHz. Figure 4 shows that the amplitude is more sensitive to convective losses, in contrast to the phase, which is more sensitive to the thermal diffusivity. The results of the sensitivity study demonstrate the importance of using both the amplitude and phase to properly estimate the thermal properties of the material.

### III. RESULTS AND DISCUSSION

At any given wavelength, the measured signal is directly proportional to the amount of IR light detected by using the camera. Thus, the chosen wavelength corresponds to the maximum transmission of the Borofloat sample, which is  $\lambda = 3300$  nm. The sample is heated at its edges at the modulated temperature  $T_c(t) = T_0 + (\Delta T/2) \sin(\omega_T t)$  with  $T_0 = 30^\circ$  C,  $\Delta T = 20^\circ$  C, and  $\omega_T = 2\pi f_T$ . To

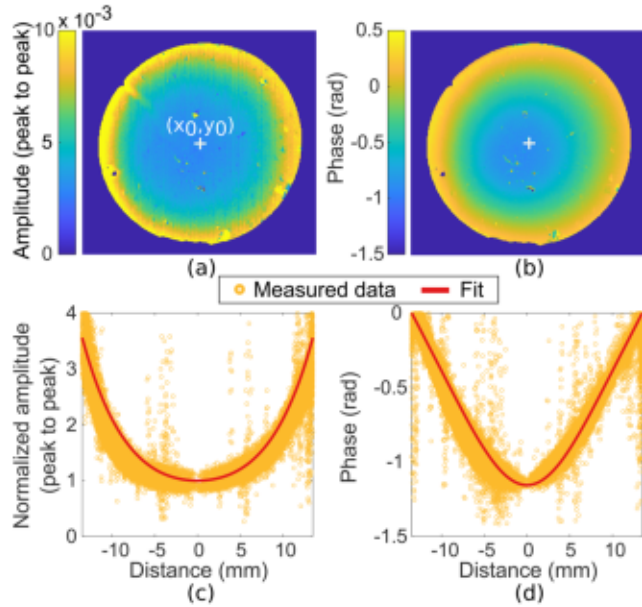
ensure that the heat diffuses to the center of the wafer, the characteristic thermal frequency is roughly estimated to be  $f \approx a/d^2 \approx 7 \times 10^{-7} / (0.013)^2 \approx 5$  mHz, and the modulation frequency is then set to  $f_T = 5$  mHz.

The measured amplitude and phase fields of the thermotransmitted signal are represented in Fig. 5. As expected, the fields are axisymmetric, and the amplitude is higher at the edges, where the sample is heated. The phase is equal to zero at the edges, in phase with the setpoint temperature. To compare the measurements to the model, each pixel position  $(x, y)$  is converted to a distance  $r = \sqrt{(x - x_0)^2 + (y - y_0)^2}$  from the center  $(x_0, y_0)$  of the sample. All corresponding data points are represented in Fig. 5(c) for the amplitude and in Fig. 5(d) for the phase. The noticeable outliers originate from scratches on the sample and unevenness on the edges of the Peltier module, but the results are not affected.

To validate the thermotransmittance method for temperature measurement, the thermal properties of the material are estimated by minimizing the norm between the model and the measurements. First, they are normalized by the data at the position  $r = 0$  [see Eq. (18)] to remove from the equation the thermotransmittance coefficient and the temperature variation at the edge  $\Delta T$ ,

$$\frac{\frac{\Delta A}{A_0}(r, \omega_T)}{\frac{\Delta A}{A_0}(0, \omega_T)} = \frac{|\theta(r, \omega_T)|}{|\theta(0, \omega_T)|}. \quad (18)$$

This step reduces the number of free parameters and increases the estimation accuracy of thermal properties of the material. To



**FIG. 5.** (a) Amplitude field measurement of the thermotransmitted signal at  $f_T = 5$  mHz and  $\lambda = 3.3 \mu\text{m}$ . The image center  $(x_0, y_0)$  is marked by the white cross. (b) Phase field measurement of the thermotransmitted signal. (c) Amplitude normalized at  $r = 0$  and (d) phase as a function of the distance to the center  $r$ . As the thermotransmittance signal is in phase opposition with the temperature,  $\pi$  was subtracted from the data. Yellow circles: data corresponding to  $5 \times 10^4$  pixels. Red curve: minimization result [see Eq. (19) and Table I].

estimate the free parameters  $a$  and  $H$ , a Matlab derivative-free algorithm (simplex algorithm from the *fminsearch* subroutine) was used to minimize the error between the model and the measurements. The cost function that measures this error was chosen based on the amplitude and phase of the signal as defined in the following equation:

$$J = \left\| \frac{|\theta(r, \omega_T)|}{|\theta(0, \omega_T)|} - \frac{\Delta A/A_0(r, \omega_T)}{\Delta A/A_0(0, \omega_T)} \right\|^2 + \|\varphi_{\text{model}}(r, \omega_T) - \varphi_{\text{measured}}(r, \omega_T)\|^2. \quad (19)$$

Considering known values<sup>27</sup> of the mass density,  $\rho = 2200 \text{ kg/m}^3$ , and the specific heat capacity,  $c_p = 800 \text{ J/kg/K}$ , of the material, the thermal conductivity,  $k = \rho c_p$ , and the convection coefficient depending on the experimental conditions,  $h = Hke/2$ , are derived and presented in Table I. The relative error is 8% for the thermal diffusivity and conductivity measurement and is close to 20% for the convection coefficient, which is satisfactory for thermal property measurement. The expected thermal properties<sup>27</sup> are  $k \approx 1.2 \text{ W/m/K}$  and  $a \approx 7 \times 10^{-7} \text{ m}^2/\text{s}$ , which are consistent with the obtained measurements. These results validate the use of thermotransmittance for thermal property estimation in semitransparent materials.

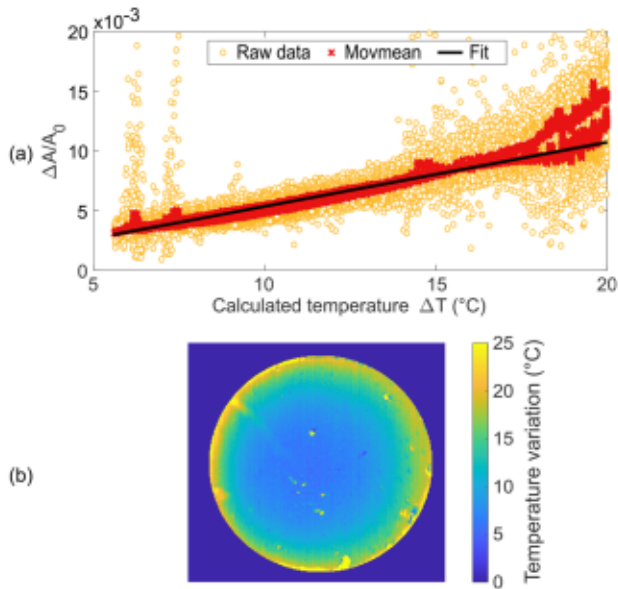
Finally, the thermotransmittance coefficient is estimated from the ratio between the temperature calculated from the model and the measured amplitude  $\Delta A/A_0$ , as represented in Fig. 6(a). Therefore, the slope of the linear fit provides the thermotransmittance coefficient  $\kappa_{\text{Borofloat}} = -(5.2 \pm 0.2) \times 10^{-4} \text{ K}^{-1}$  at  $\lambda = 3300 \text{ nm}$  for the Borofloat wafer of thickness  $515 \mu\text{m}$ . The minus sign comes from the phase opposition between the temperature and the thermotransmitted signal: the higher the temperature, the more opaque the sample.

With the knowledge of the thermotransmittance coefficient, temperature variation measurements can be performed in semitransparent media [see Fig. 6(b)]. In the current implementation of the setup (with camera electronic noise and the selected number of averaged periods), the sensitivity is  $\sigma_{\Delta A/A_0} = 0.0012$ . The noise converted into temperature with  $\kappa$  is  $\sigma_T \approx 2^\circ\text{C}$ . According to Fig. 6(b), the minimal measured temperature variation is  $\Delta T_{\text{min}} = 5^\circ\text{C} > \sigma_T$ . Therefore, the presented results are not impacted by the thermal resolution under the chosen experimental conditions.

The second interesting experimental finding is the minimal acquisition time to heat the sample  $\tau \approx d^2/a$ . For the chosen glass wafer,  $\tau \approx 200 \text{ s}$ , which corresponds to  $f_T = 5 \text{ mHz}$ . Reducing  $\tau$  means working with a smaller sample: for a micrometric sample with the same thermal diffusivity,  $\tau \approx (100^{-6})^2/a \approx 10 \text{ ms}$ . To optimize the thermotransmittance measurement performance for such

**TABLE I.** Estimation of thermal properties of the Borofloat wafer.

Parameter	Estimated value
Thermal diffusivity, $a$	$a = (7.4 \pm 0.6) \times 10^{-7} \text{ m}^2/\text{s}$
Loss factor, $H$	$H = (2.9 \pm 0.5) \times 10^4 \text{ m}^{-2}$
Thermal conductivity, $k$	$k = 1.3 \pm 0.1 \text{ W/m/K}$
Convection coefficient, $h$	$h = 9.5 \pm 1.8 \text{ W/m}^2/\text{K}$



**FIG. 6.** (a) Thermotransmitted signal as a function of the calculated temperature variation. Yellow circles: data corresponding to  $5 \times 10^4$  pixels. Red crosses: moving averages over 50 points. Solid line: linear regression. (b) Measured map of the temperature variation,  $\Delta T$ .

a sample, the heating system must be adjusted according to the dimensions of the material (using laser heating, the Joule effect, etc.). Therefore, the thermotransmittance method should provide temperature variation measurements at any size scale, requiring an adjustment of heating conditions. This paper presents an example of a millimeter system, and future work will enable the development of the method for a smaller system.

To measure the temperature in a new sample, the thermotransmittance coefficient of the material must be estimated first. As discussed in the Introduction, there is no adequate model for estimating the thermotransmittance coefficient. Drude theory<sup>31,32</sup> provides a working hypothesis for metals from which one can develop a more general model. The availability of an experimental database of thermotransmittance coefficient values of diverse materials with different thicknesses would facilitate the selection of the appropriate hypothesis depending on the nature of the material (metal,<sup>33</sup> semiconductor,<sup>34</sup> or dielectric).

The current configuration provides the average temperature of the sample over its thickness. To address the *in situ* temperature measurement in thick samples, three-dimensional (3D) thermotransmittance measurement has to be performed. Several tomography methods will be investigated, such as confocal imaging<sup>35</sup> or Radon tomography.<sup>36</sup>

#### IV. CONCLUSIONS

This study demonstrates that modulated thermotransmittance imaging is a powerful method for thermal properties and temperature measurement in semitransparent materials: the signal is directly proportional to the variation of the temperature of the material. The thermotransmittance coefficient  $\kappa$  of Borofloat 33 was measured,

as well as the thermal properties. Moreover, thermal modulation strongly increases the SNR of the measurement, which was formerly limited by electronic noise, parasitic signals, or thermal drift of the devices.

In the current setup, the time of the experiment is  $\sim 200$  s due to the low thermal frequency. To study transient phenomena, an adaptation of the current setup is necessary to lower the acquisition time. Moreover, reducing the size of the system and modifying the heat source (e.g., using a laser or the Joule effect) should enable the study of micro-devices, such as micro-supercapacitors.

Finally, thermotransmittance is expected to be a powerful method for quantitative thermal tomography in semitransparent media. Future works will focus on improving the current setup for 3D-field temperature measurements.

#### AUTHOR DECLARATIONS

##### Conflict of Interest

The authors have no conflicts to disclose.

##### Author Contributions

**C. Bourges:** Conceptualization (equal); Data curation (equal); Formal analysis (equal); Investigation (equal); Methodology (equal); Software (equal); Validation (equal); Visualization (equal); Writing – original draft (equal); Writing – review & editing (equal). **S. Chevalier:** Conceptualization (equal); Formal analysis (equal); Funding acquisition (equal); Investigation (equal); Methodology (equal); Project administration (equal); Supervision (equal); Writing – original draft (equal); Writing – review & editing (equal). **J. Maire:** Conceptualization (equal); Methodology (equal); Project administration (equal); Software (equal); Supervision (equal); Writing – original draft (equal); Writing – review & editing (equal). **A. Sommier:** Resources (equal); Software (equal); Writing – original draft (equal). **C. Pradere:** Conceptualization (equal); Funding acquisition (equal); Methodology (equal); Supervision (equal). **S. Dilhaire:** Conceptualization (equal); Methodology (equal); Project administration (equal); Supervision (equal); Writing – original draft (equal); Writing – review & editing (equal).

##### DATA AVAILABILITY

The data that support the findings of this study are available from the corresponding author upon reasonable request.

##### REFERENCES

- <sup>1</sup>K. Peng, J. Jie, W. Zhang, and S. T. Lee, "Silicon nanowires for rechargeable lithium-ion battery anodes," *Appl. Phys. Lett.* **93**, 033105 (2008).
- <sup>2</sup>K. Niazi, H. A. Khan, and F. Amir, "Hot-spot reduction and shade loss minimization in crystalline-silicon solar panels," *J. Renewable Sustainable Energy* **10**, 033506 (2018).
- <sup>3</sup>J. Shin, J. Park, and N. Park, "A method to recycle silicon wafer from end-of-life photovoltaic module and solar panels by using recycled silicon wafers," *Sol. Energy Mater. Sol. Cells* **162**, 1–6 (2017).
- <sup>4</sup>J. Gieseler, A. Adibekyan, C. Monte, and J. Hollandt, "Apparent emissivity measurement of semi-transparent materials part 1: Experimental realization," *J. Quant. Spectrosc. Radiat. Transfer* **257**, 107316 (2020).



- <sup>5</sup>M. Speka, S. Mattei, M. Pilloz, and M. Ilie, "The infrared thermography control of the laser welding of amorphous polymers," *NDT & E Int.* **41**, 178–183 (2008).
- <sup>6</sup>X. Maldague and S. Marinetti, "Pulse phase infrared thermography," *J. Appl. Phys.* **79**, 2694–2698 (1996).
- <sup>7</sup>F. Cernuschi, A. Russo, L. Lorenzoni, and A. Figari, "In-plane thermal diffusivity evaluation by infrared thermography," *Rev. Sci. Instrum.* **72**, 3988–3995 (2001).
- <sup>8</sup>G. M. Carlomagno and G. Cardone, *Exp. Fluids* **49**, 1187–1218 (2010).
- <sup>9</sup>R. Usamentiaga, P. Venegas, J. Guerediaga, L. Vega, J. Molleda, and F. G. Bulnes, "Infrared thermography for temperature measurement and non-destructive testing," *Sensors* **14**, 12305–12348 (2014).
- <sup>10</sup>C. Meola, S. Boccardi, and G. M. Carlomagno, "Measurements of very small temperature variations with LWIR QWIP infrared camera," *Infrared Phys. Technol.* **72**, 195–203 (2015).
- <sup>11</sup>S. P. Nikitin, C. Manka, J. Grun, and J. Bowles, "A technique for contactless measurement of water temperature using Stokes and anti-Stokes comparative Raman spectroscopy," *Rev. Sci. Instrum.* **83**, 033105 (2012).
- <sup>12</sup>D. S. Moore and S. D. McGrane, "Raman temperature measurement," *J. Phys.: Conf. Ser.* **500**, 192011 (2014).
- <sup>13</sup>P. Löw, B. Kim, N. Takama, and C. Bergaud, "High-spatial-resolution surface-temperature mapping using fluorescent thermometry," *Small* **4**, 908–914 (2008).
- <sup>14</sup>F. Wang, Y. Han, and N. Gu, "Cell temperature measurement for biometabolism monitoring," *ACS Sens.* **6**, 290–302 (2021).
- <sup>15</sup>W. J. Tropf and M. E. Thomas, "Infrared refractive index and thermo-optic coefficient measurement at APL," Johns Hopkins APL Tech. Dig. **19**, 293–297 (1998).
- <sup>16</sup>W. Wang, Y. Yu, Y. Geng, and X. Li, "Measurements of thermo-optic coefficient of standard single mode fiber in large temperature range," *Proc. SPIE* **9620**, 96200Y (2015).
- <sup>17</sup>H. H. Li, "Refractive index of silicon and germanium and its wavelength and temperature derivatives," *J. Phys. Chem. Ref. Data* **9**, 561–658 (1980).
- <sup>18</sup>S. Dilhaire, S. Grauby, and W. Claeys, "Calibration procedure for temperature measurements by thermoreflectance under high magnification conditions," *Appl. Phys. Lett.* **84**, 822–824 (2004).
- <sup>19</sup>D. U. Kim, K. S. Park, C. B. Jeong, G. H. Kim, and K. S. Chang, "Quantitative temperature measurement of multi-layered semiconductor devices using spectroscopic thermoreflectance microscopy," *Opt. Express* **24**, 13906 (2016).
- <sup>20</sup>D. G. Cahill, "Analysis of heat flow in layered structures for time-domain thermoreflectance," *Rev. Sci. Instrum.* **75**, 5119–5122 (2004).
- <sup>21</sup>M. Farzaneh, K. Maize, D. Luerßen, J. A. Summers, P. M. Mayer, P. E. Raad, K. P. Pipe, A. Shakouri, R. J. Ram, and J. A. Hudgings, "CCD-based thermoreflectance microscopy: Principles and applications," *J. Phys. D: Appl. Phys.* **42**, 143001 (2009).
- <sup>22</sup>J. Christofferson and A. Shakouri, "Thermoreflectance based thermal microscope," *Rev. Sci. Instrum.* **76**, 024903 (2005).
- <sup>23</sup>C. Pradere, M. Ryu, A. Sommier, M. Romano, A. Kusiak, J. L. Battaglia, J. C. Batsale, and J. Morikawa, "Non-contact temperature field measurement of solids by infrared multispectral thermotransmittance," *J. Appl. Phys.* **121**, 085102 (2017).
- <sup>24</sup>R. Mulaveesala and S. Tuli, "Theory of frequency modulated thermal wave imaging for nondestructive subsurface defect detection," *Appl. Phys. Lett.* **89**, 191913 (2006).
- <sup>25</sup>O. Breitenstein, M. Langenkamp, F. Altmann, D. Katzer, A. Lindner, and H. Eggers, "Microscopic lock-in thermography investigation of leakage sites in integrated circuits," *Rev. Sci. Instrum.* **71**, 4155–4160 (2000).
- <sup>26</sup>T. Lafargue-Tallet, R. Vaucelle, C. Caliot, A. Aouali, E. Abisset-Chavanne, A. Sommier, R. Peiffer, and C. Pradere, "Active thermo-reflectometry for absolute temperature measurement by infrared thermography on specular materials," *Sci. Rep.* **12**, 7814 (2022).
- <sup>27</sup>SCHOTT Technical Glass Solutions GmbH, Schott Borofloat 33 (2009), pp. 1–32.
- <sup>28</sup>G. Busse, D. Wu, and W. Karpen, "Thermal wave imaging with phase sensitive modulated thermography," *J. Appl. Phys.* **71**, 3962–3965 (1992).
- <sup>29</sup>S. W. Churchill and H. H. S. Chu, "Correlating equations for laminar and turbulent free convection from a vertical plate," *Int. J. Heat Mass Transfer* **18**, 1323–1329 (1975).
- <sup>30</sup>D. W. Hahn and M. N. Ozisik, *Heat Conduction*, 3rd ed. (Wiley and Sons, 2012).
- <sup>31</sup>M. A. Ordal, R. J. Bell, R. W. Alexander, L. L. Long, and M. R. Querry, "Optical properties of fourteen metals in the infrared and far infrared: Al, Co, Cu, Au, Fe, Pb, Mo, Ni, Pd, Pt, Ag, Ti, V, and W," *Appl. Opt.* **24**, 4493 (1985).
- <sup>32</sup>A. Block, M. Liebel, R. Yu, M. Spector, Y. Sivan, F. J. García De Abajo, and N. F. Van Hulst, "Tracking ultrafast hot-electron diffusion in space and time by ultrafast thermomodulation microscopy," *Sci. Adv.* **5**, eaav8965 (2019).
- <sup>33</sup>R. Rosei and D. W. Lynch, "Thermomodulation spectra of Al, Au, and Cu," *Phys. Rev. B* **5**, 3883–3894 (1972).
- <sup>34</sup>G. Ghosh, "Temperature dispersion of refractive indices in semiconductors," *J. Appl. Phys.* **79**, 9388–9389 (1996).
- <sup>35</sup>J. Jonkman, C. M. Brown, G. D. Wright, K. I. Anderson, and A. J. North, "Tutorial: Guidance for quantitative confocal microscopy," *Nat. Protoc.* **15**, 1585–1611 (2020).
- <sup>36</sup>A. G. Ramm and A. I. Katsevich, *Radon Transform and Local Tomography* (CRC Press, 2020).